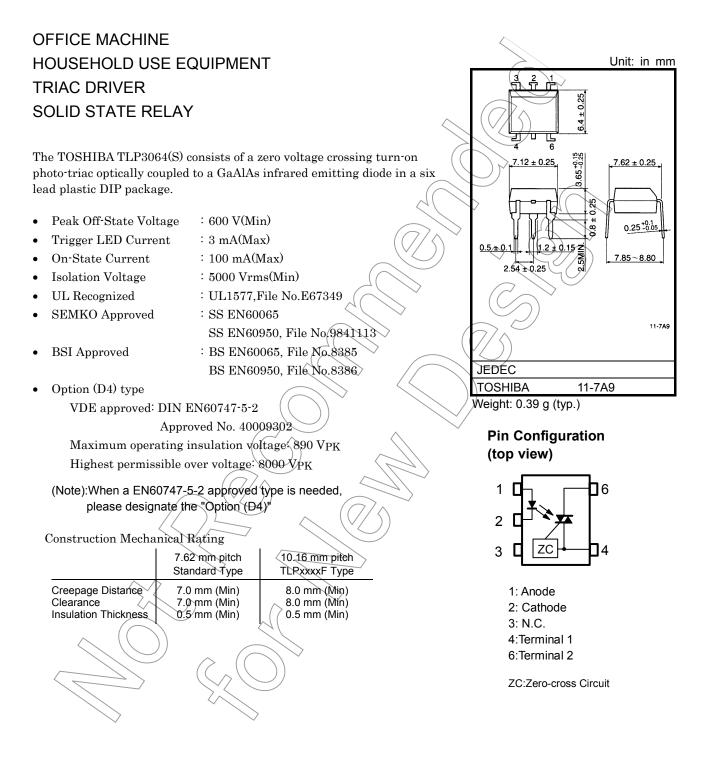
TOSHIBA PHOTOCOUPLER GaAIAs IRED & PHOTO-TRIAC

# TLP3064(S)



Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC		SYMBOL	RATING	UNIT
	Forward Current			30	mA
Q	Forward Current Derating (Ta $\ge 25^{\circ}$ C)		∆l <sub>F</sub> /°C	-0.3	mA /°C
LED	Peak Forward Current (100 $\mu$ s pulse, 100 pps)		I <sub>FP</sub>	4	А
	Reverse Voltage		V <sub>R</sub>	5	V
	Junction Temperature		Tj	125	)°¢
	Off-State Output Terminal Voltage		V <sub>DRM</sub>	600	V
	On-State RMS Current	Ta = 25°C		100	mA
OR		Ta = 70°C		IF         30           IF/°C         -0.3           IFP         1           VR         5           Tj         125           'DRM         600           (RMS)         50           IT/°C         -1.1           ITP         2           TSM         1.2           Tj         415           Topp         -55 to 450           Topp         -40 to 100           Tsol         260	110 (
DETECTOR	On-State Current Derating (Ta $\ge 25^{\circ}$ C)	·	∆l <sub>T</sub> /°C		mA /°C
DE	Peak On-State Current (100 $\mu$ s pulse, 120 pps)		ПТР	2	A
	Peak Nonrepetitive Surge Current (Pw = 10 ms)	G	ITSM	1.2	A
	Junction Temperature	∫ ∫īj	A15 (	00	
Stor	age Temperature Range		T <sub>stg</sub>	-55 to 150	°C
Оре	erating Temperature Range		🔾 Т <sub>орг</sub>	-40 to 100	C
Lea	d Soldering Temperature (10 s)	$\langle \langle \rangle$	T <sub>sol</sub>	260	) °C
Isola	ation Voltage (AC, 1 min., R.H.≤60%)	(Note 2)	BVS	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 2) Device considered a two terminal device:Pins1, 2 and 3 shorted together and pin 4 and pin 6 shorted together.

#### **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN.	-TYP.	MAX.	UNIT
Supply Voltage	V <sub>AC</sub>	Þ		240	Vac
Forward Current	F	4.5	6	7.5	mA
Peak On-State Current	ITTP	_	_	1	А
Operating Temperature	Topr	-10		85	°C

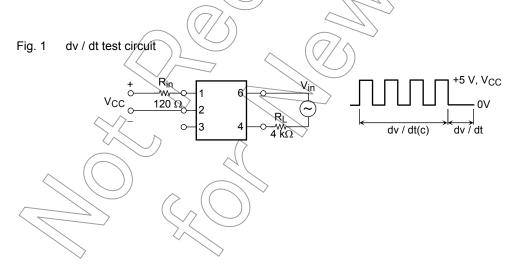
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### Individual Electrical Characteristics (Ta=25°C)

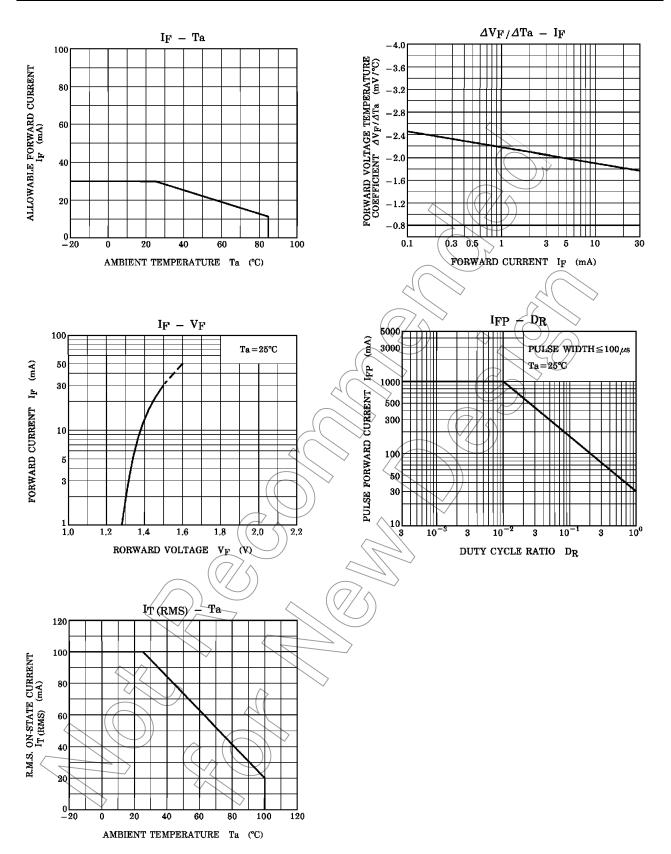
	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_<	30	—	pF
R	Peak Off-State Current	I <sub>DRM</sub>	V <sub>DRM</sub> = 600 V	—	10	1000	nA
	Peak On-State Voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA	—	$\langle - \rangle$	3.0	V
CTC	Holding Current	Ι <sub>Η</sub>	—	$\square$	0.6	_	mA
DETECTOR	Critical Rate of Rise of Off-State Voltage	dv / dt	Vin = 240 Vrms, Ta = 85°C (Fig.1)	200	500	_	V/µs
	Critical Rate of Rise of Commutating Voltage	dv / dt(c)	Vin = 60 Vrms, $I_T$ = 15 mA (Fig(1))	LP L	0.2	_	V/µs

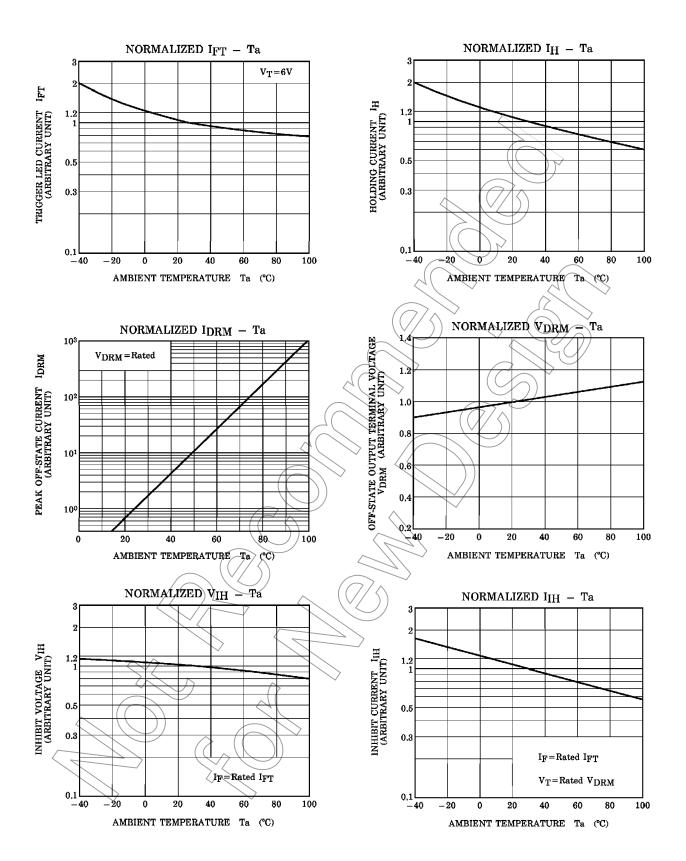
## Coupled Electrical Characteristics (Ta=25°C)

			\\	$\langle \ \rangle$	//	
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX	UNIT
Trigger LED Current	I <sub>FT</sub>	V <sub>T</sub> = 3 V ,Resistive Load	_((	(F	3	mA
Inhibit Voltage	VIH	IF = Rated IFT		Ì	50	V
Leakage in Inhibited State	IIН	IF = Rated IFT, VT = Rated VDRM	(45)	) —	600	μA
Capacitance (Input to Output)	CS	V <sub>S</sub> =0, f=1MHz		0.8	_	pF
Isolation Resistance	Rs	V <sub>S</sub> = 500 V, R.H.≤60%	1×10 <sup>12</sup>	10 <sup>14</sup>		Ω
	(	AC, 1 minute	5000			Vrms
Isolation Voltage	BVS	AC, 1 second, in oil		10000	_	V1115
		DC, 1 minute, in oil	_	10000	_	Vdc



# TOSHIBA





#### **RESTRICTIONS ON PRODUCT USE**

- Toshiba Corporation, and its subsidiaries and affiliates (collectively "TOSHIBA"), reserve the right to make changes to the information in this document, and related hardware, software and systems (collectively "Product") without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- Product is intended for use in general electronics applications (e.g., computers, personal equipment, office equipment, measuring equipment, industrial robots and home electronics appliances) or for specific applications as expressly stated in this document. Product is neither intended nor warranted for use in equipment or systems that require extraordinarily high levels of quality and/or reliability and/or a malfunction or failure of which may cause loss of human life bodily injury, serious property damage or serious public impact ("Unintended Use"). Unintended Use includes, without limitation, equipment used in nuclear facilities) equipment used in the aerospace industry, medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, devices related to electric power, and equipment used in finance-related fields. Do not use Product for Unintended Use unless specifically permitted in this document.
- · Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
  limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
  technology products (mass destruction weapons). Product and related software and technology may be controlled under the
  Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product
  or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA assumes no liability for damages or losses occurring as a result of noncompliance with applicable laws and regulations.

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Toshiba: TLP3064(S,C,F) TLP3064SCF





Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.З, офис 1107

#### Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

#### http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

#### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж: moschip.ru moschip.ru\_4

moschip.ru\_6 moschip.ru\_9